

Quad 2-Input OR Gate

MM74HCT32

General Description

The MM74HCT32 is a logic function fabricated by using advanced silicon-gate CMOS technology, which provides the inherent benefits of CMOS — low quiescent power and wide power supply range. This device is input and output characteristic and pin-out compatible with standard 74LS logic families. All inputs are protected from static discharge damage by internal diodes to V_{CC} and ground.

MM74HCT devices are intended to interface between TTL and NMOS components and standard CMOS devices. These parts are also plug-in replacements for LS-TTL devices and can be used to reduce power consumption in existing designs.

Features

- TTL, LS Pin-out and Threshold Compatible
- Fast Switching: t_{PLH} , t_{PHL} = 10 ns (Typ.)
- Low Power: 10 μ W at DC
- High Fan-out, 10 LS-TTL Loads
- These Devices are Pb-Free, Halide Free and are RoHS Compliant

Connection Diagram

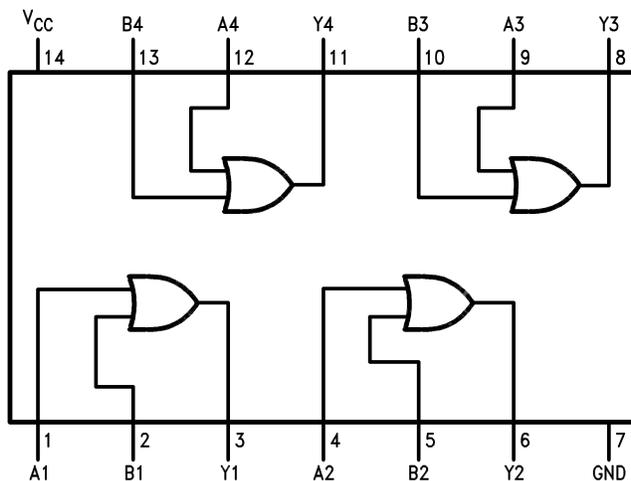


Figure 1. Pin Assignments for SOIC and TSSOP

Logic Diagram

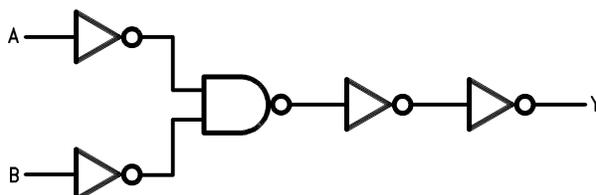
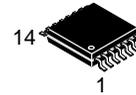


Figure 2. Logic Diagram

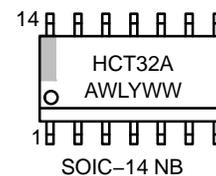


SOIC-14 NB
CASE 751A-03

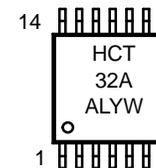


TSSOP-14 WB
CASE 948G

MARKING DIAGRAM



SOIC-14 NB



TSSOP-14

HCT32A = Specific Device Code
A = Assembly Location
WL, L = Wafer Lot
Y = Year
WW, W = Work Week

ORDERING INFORMATION

See detailed ordering and shipping information on page 3 of this data sheet.

MM74HCT32

ABSOLUTE MAXIMUM RATINGS (Note 1)

Symbol	Parameter		Rating
V_{CC}	Supply Voltage		-0.5 to +7.0 V
V_{IN}	DC Input Voltage		-0.5 to $V_{CC} + 0.5$ V
V_{OUT}	DC Output Voltage		-0.5 to $V_{CC} + 0.5$ V
I_{IK}, I_{OK}	Clamp Diode Current		± 20 mA
I_{OUT}	DC Output Current, per Pin		± 25 mA
I_{CC}	DC V_{CC} or GND Current, per Pin		± 50 mA
T_{STG}	Storage Temperature Range		-65°C to +150°C
P_D	Power Dissipation	S.O. Package Only	500 mW
T_L	Lead Temperature (Soldering 10 Seconds)		260°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Unless otherwise specified all voltages are referenced to ground.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V_{CC}	Supply Voltage	4.5	5.5	V
V_{IN}, V_{OUT}	DC Input or Output Voltage	0	V_{CC}	V
T_A	Operating Temperature Range	-40	+85	°C
t_r, t_f	Input Rise or Fall Times	-	500	ns

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

DC CHARACTERISTICS ($V_{CC} = 5$ V $\pm 10\%$ (unless otherwise specified))

Symbol	Parameter	Conditions	$T_A = 25^\circ\text{C}$		$T_A = -40^\circ\text{C to } 85^\circ\text{C}$		Unit
			Typ	Guaranteed Limits			
V_{IH}	Minimum HIGH Level Input Voltage		-	2.0	2.0		V
V_{IL}	Maximum LOW Level Input Voltage		-	0.8	0.8		V
V_{OH}	Minimum HIGH Level Output Voltage	$V_{IN} = V_{IH}$ or V_{IL} , $ I_{OUT} = 20 \mu\text{A}$	V_{CC}	$V_{CC} - 0.1$	$V_{CC} - 0.1$		V
		$V_{IN} = V_{IH}$ or V_{IL} , $ I_{OUT} = 4.0$ mA, $V_{CC} = 4.5$ V	4.2	3.98	3.84		
		$V_{IN} = V_{IH}$ or V_{IL} , $ I_{OUT} = 4.8$ mA, $V_{CC} = 5.5$ V	5.2	4.98	4.84		
V_{OL}	Maximum LOW Level Voltage	$V_{IN} = V_{IH}$, $ I_{OUT} = 20 \mu\text{A}$	0	0.1	0.1		V
		$V_{IN} = V_{IH}$, $ I_{OUT} = 4.0$ mA, $V_{CC} = 4.5$ V	0.2	0.26	0.33		
		$V_{IN} = V_{IH}$, $ I_{OUT} = 4.8$ mA, $V_{CC} = 5.5$ V	0.2	0.26	0.33		
I_{IN}	Maximum Input Current	$V_{IN} = V_{CC}$ or GND, V_{IH} or V_{IL}	-	± 0.1	± 1.0		μA
I_{CC}	Maximum Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0 \mu\text{A}$	-	2.0	20		μA
		$V_{IN} = 2.4$ V or 0.5 V (Note 2)	-	1.2	1.4		mA

2. This is measured per input with all other inputs held at V_{CC} or ground.

MM74HCT32

AC CHARACTERISTICS ($V_{CC} = 5.0\text{ V}$, $t_r = t_f = 6\text{ ns}$, $C_L = 15\text{ pF}$, $T_A = 25^\circ\text{C}$ (unless otherwise noted))

Symbol	Parameter	Conditions	Typ	Guaranteed Limit	Unit
t_{PLH} , t_{PHL}	Maximum Propagation Delay		10	–	ns

AC CHARACTERISTICS ($V_{CC} = 5.0\text{ V} \pm 10\%$, $t_r = t_f = 6\text{ ns}$, $C_L = 15\text{ pF}$ (unless otherwise noted))

Symbol	Parameter	Conditions	$T_A = 25^\circ\text{C}$		$T_A = -40^\circ\text{C to } 85^\circ\text{C}$	
			Typ	Guaranteed Limits		Unit
t_{PLH} , t_{PHL}	Maximum Propagation Delay		12	20	25	ns
t_{THL} , t_{TLH}	Maximum Output Rise & Fall Time		8	15	19	ns
C_{PD}	Power Dissipation Capacitance	(Note 3)	48	–	–	pF
C_{IN}	Maximum Input Capacitance		5	10	10	pF

3. C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} V_{CC} f + I_{CC}$.

ORDERING INFORMATION

Part Number	Package	Shipping†
MM74HCT32M	SOIC–14, Case 751A–03 (Pb–Free, Halide–Free)	55 Units / Tube
MM74HCT32MX	SOIC–14, Case 751A–03 (Pb–Free, Halide–Free)	2500 Units / Tape & Reel
MM74HCT32MTCX	TSSOP–14, Case 948G–01 (Pb–Free, Halide Free)	2500 Units / Tape & Reel

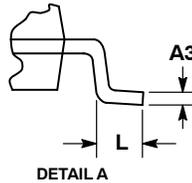
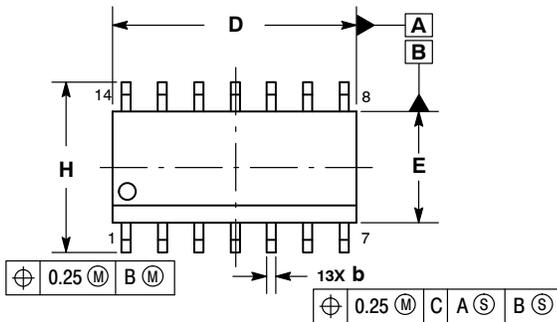
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



SCALE 1:1

SOIC-14 NB
CASE 751A-03
ISSUE L

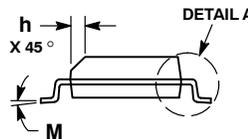
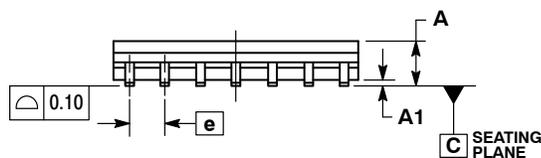
DATE 03 FEB 2016



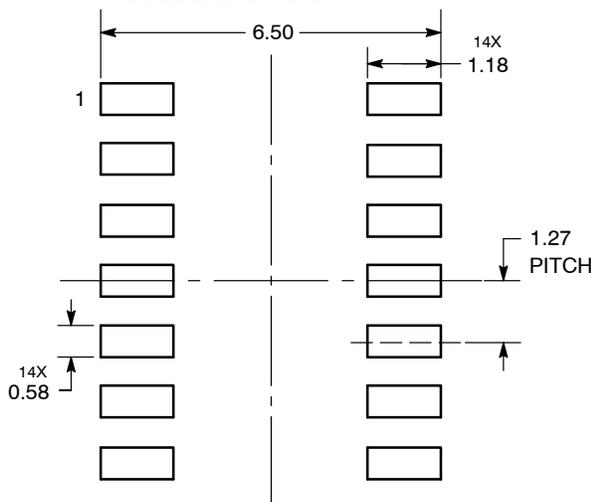
NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF AT MAXIMUM MATERIAL CONDITION.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSIONS.
5. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.35	1.75	0.054	0.068
A1	0.10	0.25	0.004	0.010
A3	0.19	0.25	0.008	0.010
b	0.35	0.49	0.014	0.019
D	8.55	8.75	0.337	0.344
E	3.80	4.00	0.150	0.157
e	1.27 BSC		0.050 BSC	
H	5.80	6.20	0.228	0.244
h	0.25	0.50	0.010	0.019
L	0.40	1.25	0.016	0.049
M	0°	7°	0°	7°



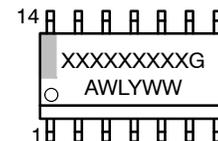
SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC MARKING DIAGRAM*



- XXXXXX = Specific Device Code
- A = Assembly Location
- WL = Wafer Lot
- Y = Year
- WW = Work Week
- G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

STYLES ON PAGE 2

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SOIC-14
CASE 751A-03
ISSUE L

DATE 03 FEB 2016

STYLE 1:
 PIN 1. COMMON CATHODE
 2. ANODE/CATHODE
 3. ANODE/CATHODE
 4. NO CONNECTION
 5. ANODE/CATHODE
 6. NO CONNECTION
 7. ANODE/CATHODE
 8. ANODE/CATHODE
 9. ANODE/CATHODE
 10. NO CONNECTION
 11. ANODE/CATHODE
 12. ANODE/CATHODE
 13. NO CONNECTION
 14. COMMON ANODE

STYLE 2:
 CANCELLED

STYLE 3:
 PIN 1. NO CONNECTION
 2. ANODE
 3. ANODE
 4. NO CONNECTION
 5. ANODE
 6. NO CONNECTION
 7. ANODE
 8. ANODE
 9. ANODE
 10. NO CONNECTION
 11. ANODE
 12. ANODE
 13. NO CONNECTION
 14. COMMON CATHODE

STYLE 4:
 PIN 1. NO CONNECTION
 2. CATHODE
 3. CATHODE
 4. NO CONNECTION
 5. CATHODE
 6. NO CONNECTION
 7. CATHODE
 8. CATHODE
 9. CATHODE
 10. NO CONNECTION
 11. CATHODE
 12. CATHODE
 13. NO CONNECTION
 14. COMMON ANODE

STYLE 5:
 PIN 1. COMMON CATHODE
 2. ANODE/CATHODE
 3. ANODE/CATHODE
 4. ANODE/CATHODE
 5. ANODE/CATHODE
 6. NO CONNECTION
 7. COMMON ANODE
 8. COMMON CATHODE
 9. ANODE/CATHODE
 10. ANODE/CATHODE
 11. ANODE/CATHODE
 12. ANODE/CATHODE
 13. NO CONNECTION
 14. COMMON ANODE

STYLE 6:
 PIN 1. CATHODE
 2. CATHODE
 3. CATHODE
 4. CATHODE
 5. CATHODE
 6. CATHODE
 7. CATHODE
 8. ANODE
 9. ANODE
 10. ANODE
 11. ANODE
 12. ANODE
 13. ANODE
 14. ANODE

STYLE 7:
 PIN 1. ANODE/CATHODE
 2. COMMON ANODE
 3. COMMON CATHODE
 4. ANODE/CATHODE
 5. ANODE/CATHODE
 6. ANODE/CATHODE
 7. ANODE/CATHODE
 8. ANODE/CATHODE
 9. ANODE/CATHODE
 10. ANODE/CATHODE
 11. COMMON CATHODE
 12. COMMON ANODE
 13. ANODE/CATHODE
 14. ANODE/CATHODE

STYLE 8:
 PIN 1. COMMON CATHODE
 2. ANODE/CATHODE
 3. ANODE/CATHODE
 4. NO CONNECTION
 5. ANODE/CATHODE
 6. ANODE/CATHODE
 7. COMMON ANODE
 8. COMMON ANODE
 9. ANODE/CATHODE
 10. ANODE/CATHODE
 11. NO CONNECTION
 12. ANODE/CATHODE
 13. ANODE/CATHODE
 14. COMMON CATHODE

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